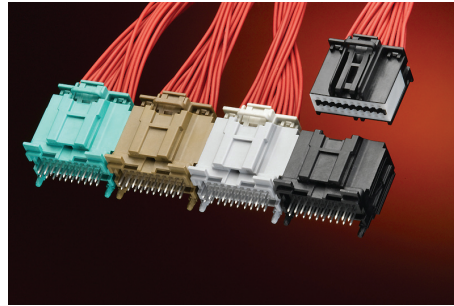




## Stac64™ 2.54mm (.100") Single, Multi-Pocket and Hybrid Header System

Electronic device requirements for today's vehicles are rapidly expanding. The Molex 2.54mm (.100") pitch header system allows OEMs and device manufacturers greater design flexibility. The Stac64™ system allows automotive manufacturers the ability to use header assemblies as stand-alone components as well as the option to gang individual headers into a larger header assembly.

The Stac64 system is based on USCAR-2 Class II mechanical and electrical requirements for unsealed 0.64mm (.025") blade-width terminal applications. Stac64 pockets mate to existing wire harness connectors designed to this industry footprint.



### Features and Benefits

#### Single and Multi-Pocket Header System

- High-temperature thermoplastic housing withstands lead-free processing per Molex ES40000-5013
- Vertical and right-angle 20-circuit headers feature 4 polarization options with each option being color coded per USCAR specifications to match harness/connector color-coding scheme for visual aid during assembly
- 8, 12 and 16-circuit right angle and vertical, 0.64mm (.025") headers available in polarization style A providing flexibility to mix and match circuit sizes for specific application requirements
- Modular housing design supports single and multi-pockets applications
- Pre-assembled PC tail with mylar alignment plate ensures proper PCB installation

- Unique power hybrid pocket design supports industry standard 1.50 and 2.80mm (.059 and .110") blade-width terminals
- USCAR approved Category 0, tin-plated pins to meet mechanical and electrical requirements of USCAR-2 Class II applications
- Operating temperature of -40 to 100°C
- Product Specs available: 34691-1000 and 34696-1000

### Features and Benefits

#### Hybrid Assemblies

- High-temperature thermoplastic housing withstands lead-free processing per Molex ES40000-5013
- Six 1.50mm (.059") terminals and four 2.80mm (.110") terminals in one header package meets high-power contact requirements for Category 2 and Category 3 terminal systems
- Modular housing design allows for packaging with 0.64mm (.025") headers to build power and signal interface
- Smaller footprint than industry standard 1.50mm and 2.80mm (.059 and .110") PCB headers for module and PCB space savings
- 1.50mm (.059") blades rated for 15.0A and 2.80mm (.110") rated for 25.0A meeting USCAR-2 blade terminal load requirements

## SPECIFICATIONS

### Reference Information

Packaging: Trays or tubes  
 Mates With: 31408 0.64mm (.025") receptacle  
 31372 hybrid receptacle  
 Designed In: Millimeters

### Electrical

Voltage: 250V  
 Current: 0.64mm (.025") terminals -5.0A  
 1.50mm (.059") terminals -15.0A  
 2.80mm (.110") terminals -25.0A  
 Dielectric Withstanding Voltage: 500V  
 Insulation Resistance: 20 Megohms min.

### Mechanical

Mate force: 75N per pocket max.  
 Unmating Mate force: 75N per pocket max.  
 Connector Lock Strength: 110N min.  
 Terminal Retention in Header:  
 0.64mm (.025") terminals - 30N  
 1.50mm (.059") terminals - 70N  
 2.80mm (.110") terminals - 70N

### Physical

Terminal Pitch: 2.54mm (.100"), horizontal and vertical for 0.64mm (.025") pockets  
 Housing: 30% glass-filled SPS  
 Contact: Copper alloy  
 Plating: Overall – 100% pure tin, lead-free  
 Underplating – Nickel  
 Operating Temperature: USCAR Class II  
 -40 to +100°C



# Stac64™ 2.54mm (.100") Single, Multi-Pocket and Hybrid Header System

- Automotive
  - Radios and amplifiers
  - Interior lighting
  - Instrument clusters
  - Power seat modules
  - Door zone modules
  - Navigation
  - DVD players
  - Instrument clusters

- Transportation
  - Interior electronics
  - Body electronics



## ORDERING INFORMATION

### Standard Headers

| Order No.  | Circuit Size | Description                            | Polarization Style | Color |
|------------|--------------|----------------------------------------|--------------------|-------|
| 34690-0200 | 20           | Stac64 vertical header assembly        | A                  | Black |
| 34690-0201 | 20           | Stac64 vertical header assembly        | B                  | Gray  |
| 34690-0202 | 20           | Stac64 vertical header assembly        | C                  | Brown |
| 34690-0203 | 20           | Stac64 vertical header assembly        | D                  | Green |
| 34691-0200 | 20           | Stac64 right angle header assembly     | A                  | Black |
| 34691-0201 | 20           | Stac64 right angle header assembly     | B                  | Gray  |
| 34691-0202 | 20           | Stac64 right angle header assembly     | C                  | Brown |
| 34691-0203 | 20           | Stac64 right angle header assembly     | D                  | Green |
| 34690-0160 | 16           | Stac64 vertical header assembly        | A                  | Black |
| 34691-0160 | 16           | Stac64 right angle header assembly     | A                  | Black |
| 34690-0120 | 12           | Stac64 vertical header assembly        | A                  | Black |
| 34691-0120 | 12           | Stac64 right angle header assembly     | A                  | Black |
| 34690-0080 | 8            | Stac64 vertical header assembly        | A                  | Black |
| 34691-0080 | 8            | Stac64 right angle header assembly     | A                  | Black |
| 34695-0100 | 10           | Power Stac vertical header assembly    | A                  | Black |
| 34696-0100 | 10           | Power Stac right angle header assembly | A                  | Black |

### Ganged Assemblies

| Series | Description            | Ordering information |
|--------|------------------------|----------------------|
| 34707  | Vertical Assemblies    | Contact Molex        |
| 34708  | Right Angle Assemblies | Contact Molex        |

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Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

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